

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT										
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Dai-Gil Lee</td> <td>09/18/2007</td> </tr> <tr> <td>Sang-Wook Park</td> <td>09/18/2007</td> </tr> <tr> <td>Byung-Chul Kim</td> <td>09/18/2007</td> </tr> <tr> <td>Seong-su Kim</td> <td>09/18/2007</td> </tr> </tbody> </table>		Name	Execution Date	Dai-Gil Lee	09/18/2007	Sang-Wook Park	09/18/2007	Byung-Chul Kim	09/18/2007	Seong-su Kim	09/18/2007
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Byung-Chul Kim	09/18/2007										
Seong-su Kim	09/18/2007										
<b>RECEIVING PARTY DATA</b>											
<b>Name:</b>	Korea Advanced Institute of Science and Technology										
<b>Street Address:</b>	373-1 Guseong-Dong, Yuseong-gu										
<b>City:</b>	Daejeon										
<b>State/Country:</b>	KOREA, REPUBLIC OF										
<b>Postal Code:</b>	305-701										
<b>PROPERTY NUMBERS Total: 1</b>											
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11777155</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11777155						
Property Type	Number										
Application Number:	11777155										
<b>CORRESPONDENCE DATA</b>											
<b>Fax Number:</b>	(949)760-9502										
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<b>NAME OF SUBMITTER:</b>	Mincheol Kim										
Total Attachments: 1											

**CH \$40.00 11777155**

**500358774**

**PATENT  
 REEL: 019856 FRAME: 0795**



Application No. 11/777,155  
Filing Date: July 12, 2007

PATENT  
Client Code: DYNE9002AUS  
Page 1

ASSIGNMENT


WHEREAS, I, the undersigned, have invented certain new and useful improvements in LIQUID TIGHT SEALING OF HEAT-INSULATING WALLS OF A LIQUEFIED NATURAL GAS CARRIER for which I filed U.S. Application No. 11/777,155 on July 12, 2007,

AND WHEREAS, Korea Advanced Institute of Science and Technology (hereinafter "ASSIGNEE"), with its principal place of business at 373-1 Guseong-Dong, Yuseong-gu, Daejeon 305-701, Republic of Korea, desires to acquire the entire right, title, and interest in and to the said improvements and the said Application:

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I do hereby acknowledge that I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest, to and under the said improvements, and the said Application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof; and I hereby authorize and request the Commissioner of Patents of the United States of America to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

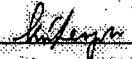
AND I DO HEREBY sell, assign, transfer, and convey to ASSIGNEE, his successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of the said Letters Patent before or after issuance.

AND I HEREBY covenant and agree that I will communicate to the said ASSIGNEE, successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Signature:  Date: September 18, 2007  
Name of inventor: Dal-Gil LEE  
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Signature:  Date: September 18, 2007  
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Signature:  Date: September 18, 2007  
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08/26/07